2SB1592

Silicon PNP epitaxial planar type

For low-frequency power amplification

■ Features

- ullet Low collector-emitter saturation voltage $V_{CE(sat)}$
- Allowing supply with the radial taping

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter Symbol Rating Unit	
Collector-base voltage (Emitter open) V _{CBO} -30 V	
Collector-emitter voltage (Base open) V_{CEO} -25 V $0.45^{+0.2}_{-0.1}$ $0.45^{+0.15}_{-0.1}$	-
Emitter-base voltage (Collector open) V_{EBO} -11 V (1.27) (1.27) (1.27) (1.27)	
Collector current I _C -3 A (1: Emitter
Peak collector current I _{CP} -10 A 2.54±0.15	2: Collect
Collector power dissipation P _C 1.0 W	3: Base -A1 Packay
Junction temperature T _j 150 °C	9
Storage temperature T_{stg} -55 to +150 °C	100
Note) *: Pulse width ≤ 1 ms, 1 shot	iol.
■ Electrical Characteristics T _a = 25°C ± 3°C	



Unit: mm 1. Emitter 2: Collector 3: Base TO-92NL-A1 Packag

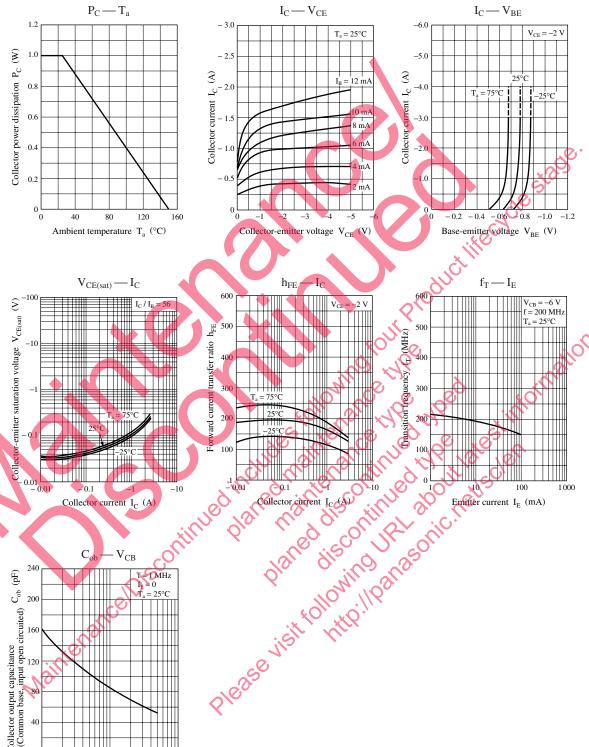
Electrical Characteristics T_a = 25°C ±

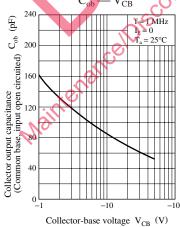
Parameter	Symbol	Conditions Min Typ Max	Unit
Collector-base voltage (Emitter open)	V _{ČBO}	$I_C = -10 \mu A, I_E = 0$	V
Collector-emitter voltage (Base open)	V_{CEO}	$I_{\rm C} = -1 \text{ mA}, I_{\rm B} = 0$ 25	V
Emitter-base voltage (Collector open)	V_{EBO}	$I_{\rm E} = -10 \mu A, I_{\rm C} = 0$ -11	V
Forward current transfer ratio	h _{FE}	$V_{CE} = 2 V, I_C = -1.4 A$ 130 450	_
Collector-emitter saturation voltage *	V _{CE(sat)}	$I_C = -1.4 \text{ A}, I_B = -25 \text{ mA}$ $-0.16 -0.22$	V
Transition frequency	f_T	$V_{CB} = -6 \text{ V}, I_{E} = 50 \text{ mA} \text{ f} = 200 \text{ MHz}$ 150	MHz
Collector output capacitance	Cob	$V_{CB} = -10 \text{ V}, I_E = 0 \text{ f} = 1 \text{ MHz}$ 85	pF
(Common base, input open circuited)			

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2.4: Pulse measurement

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